

LOC		DIST		REVISIONS					
AA		22		REV	LYR	DESCRIPTION	DATE	DWN	APVD
				A		ECR-10-023281	17NOV2010	JJ	MOW

D

C

B

A

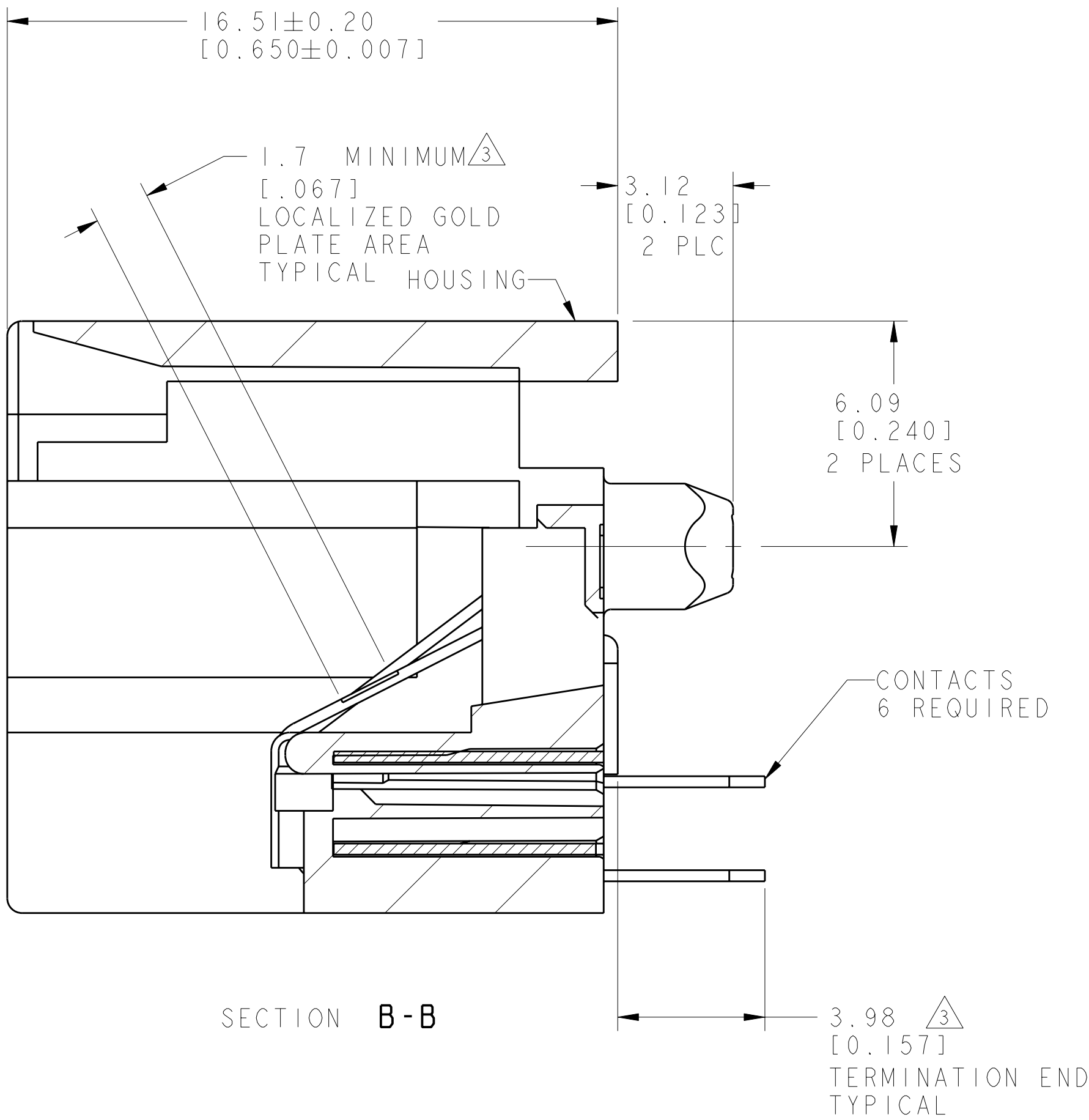
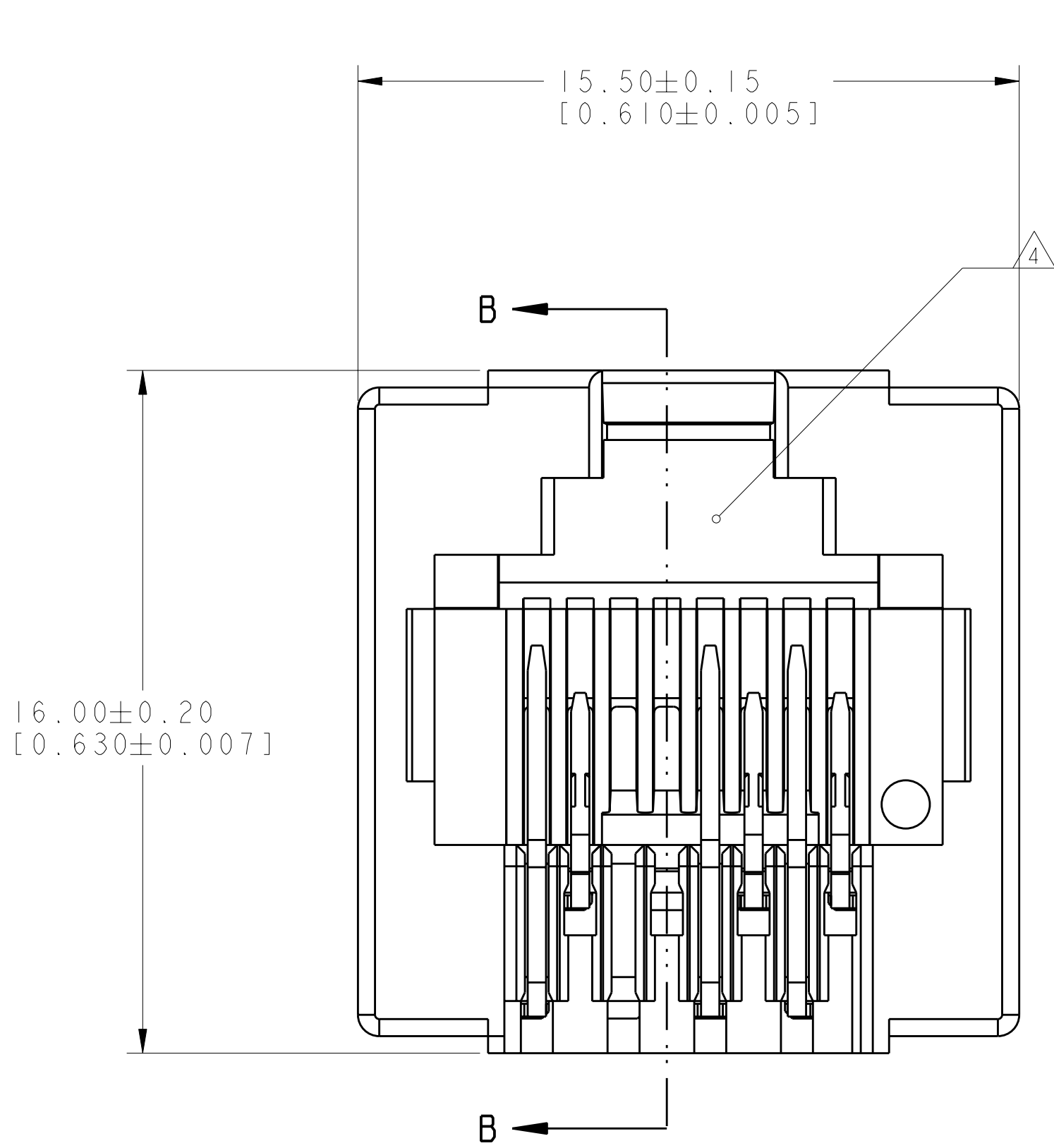
D

C

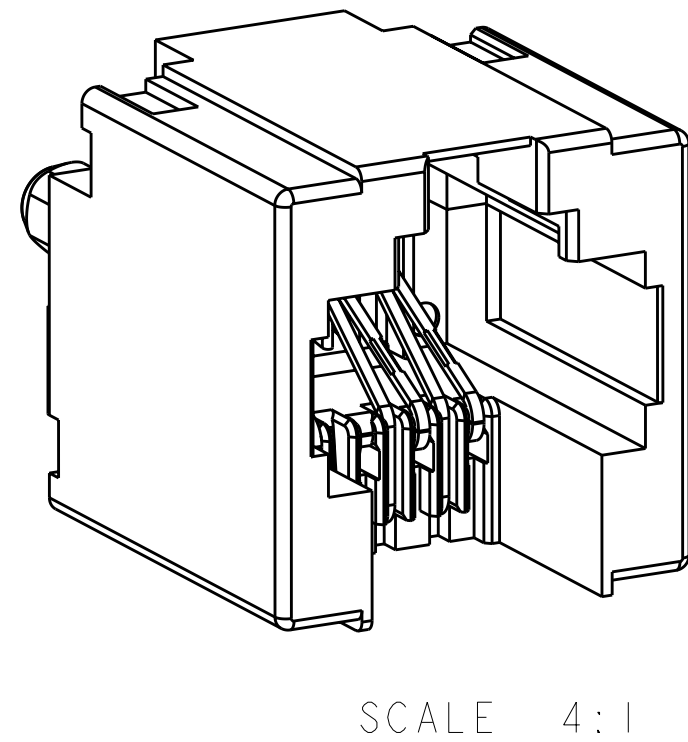
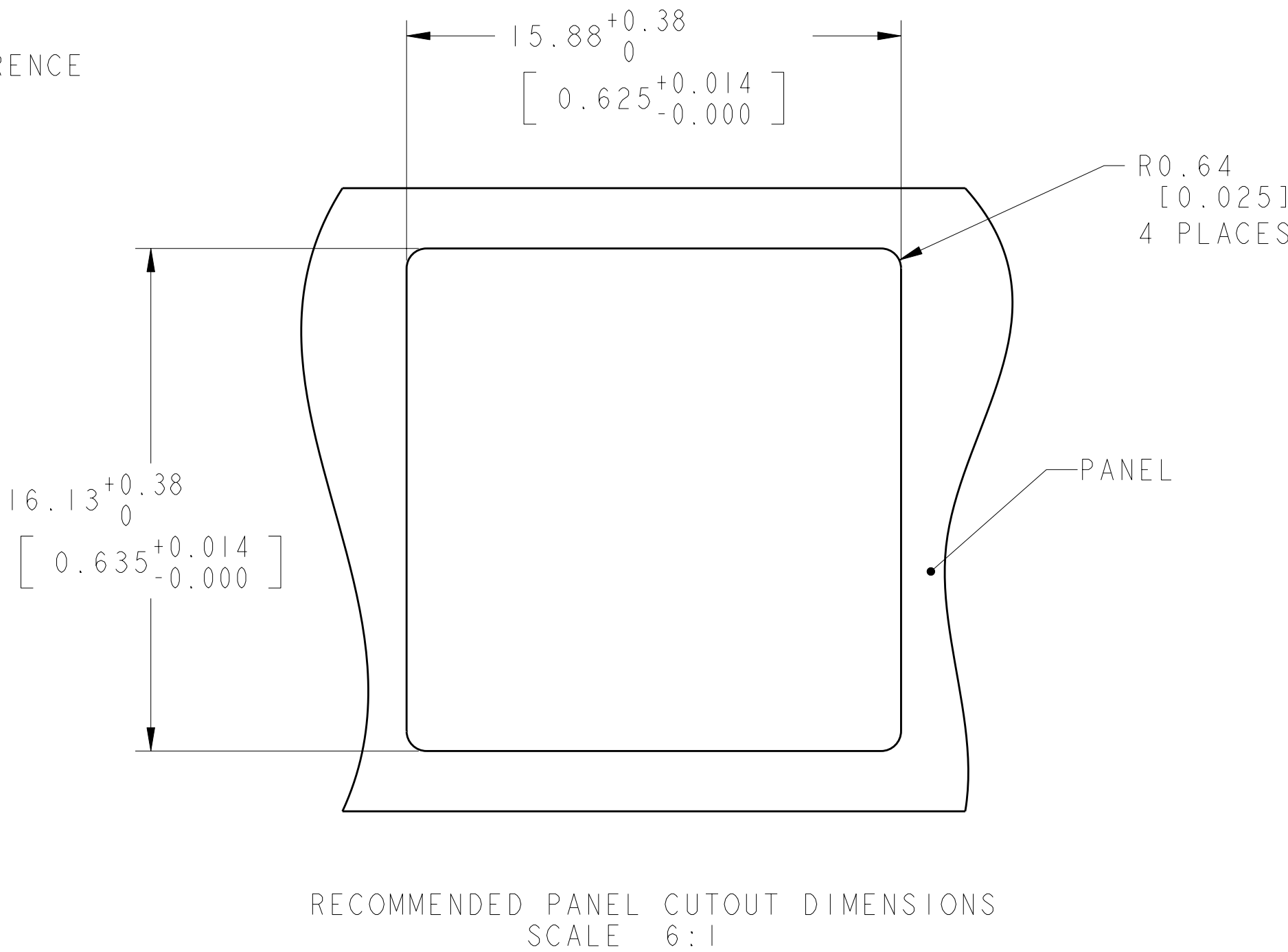
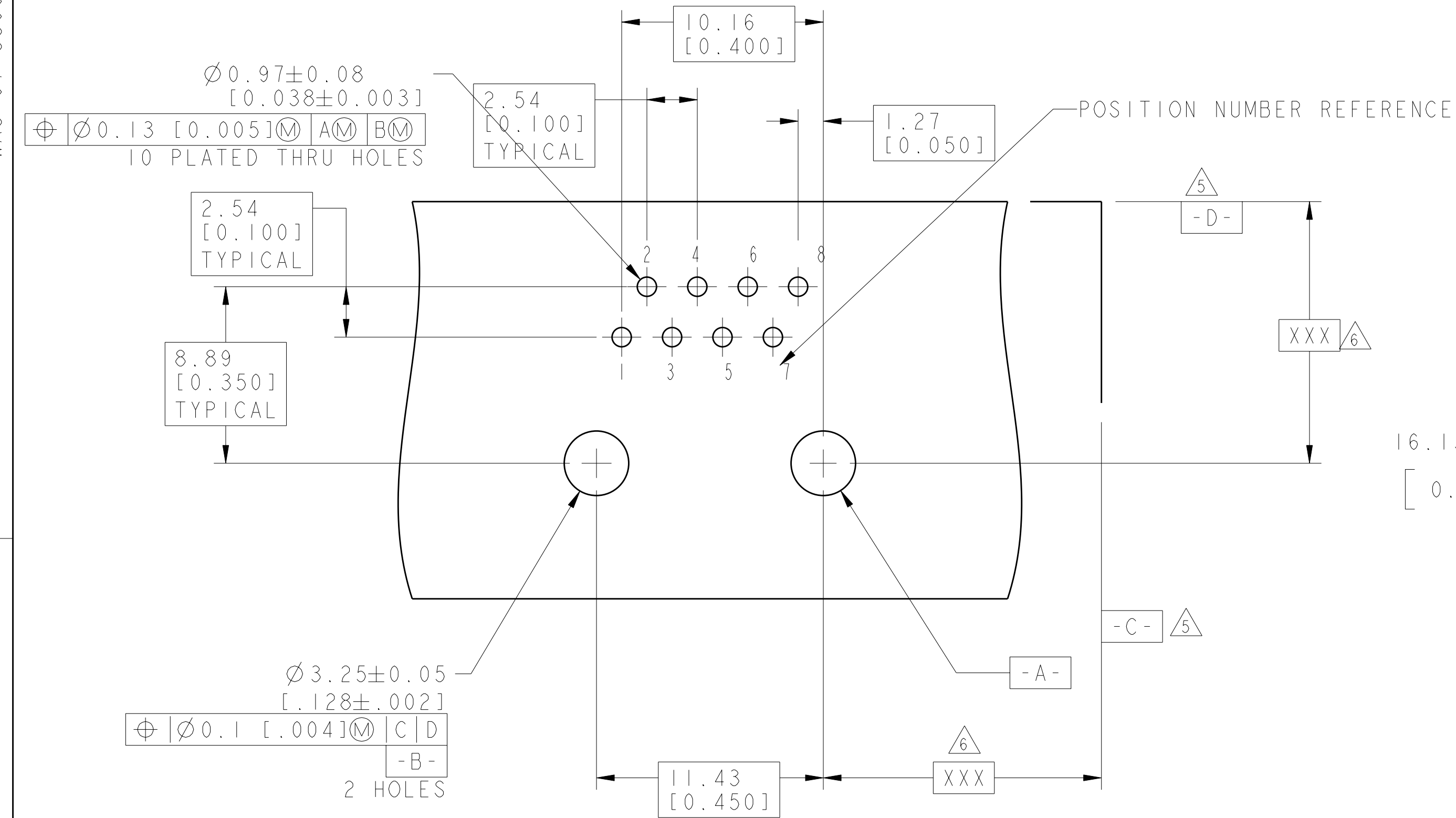
B

A

WAS 97-8309-65-1



- 1 THERMOPLASTIC, COLOR-BLACK
- 2 PHOSPHOR BRONZE
- 3 $1.27 \mu\text{m}$ [0.00050] MIN GOLD IN LOCALIZED GOLD PLATE AREA, $2 \mu\text{m}$ [0.00079] MIN MATTE TIN ON TERMINATION END, BOTH OVER $1.27 \mu\text{m}$ [0.00050] MIN NICKEL
- 4 CAVITY CONFORMS TO FCC 47 CFR 68 PART F
- 5 DATUMS ESTABLISHED BY CUSTOMER
- 6 DIMENSIONS ESTABLISHED BY CUSTOMER
- 7 COPPER ZINC ALLOY
- 8 $2.03 \mu\text{m}$ [0.00080] MIN BRIGHT TIN OVER $1.27 \mu\text{m}$ [0.00050] MIN NICKEL



RECOMMENDED
PRINTED CIRCUIT BOARD
LAYOUT
RECOMMENDED PRINTED CIRCUIT BOARD
THICKNESS 1.4 [0.055] MIN
COMPONENT SIDE OF PRINTED CIRCUIT BOARD

TYPICAL DIMENSIONS TO CENTERLINE UNLESS OTHERWISE SPECIFIED		DWN	JJ	17NOV2010	Tyco Electronics Corporation Shanghai, R.P.China 200233						
DIMENSIONS: mm [INCHES]		CHK	D. ZHU	17NOV2010							
		APVD	MO WANG	17NOV2010	NAME	MODULAR JACK ASSEMBLY, VERTICAL, THRU HOLE, 8 POSITION, 6CONTACTS					
		PRODUCT SPEC									
		108-1163-6									
		APPLICATION SPEC		SIZE	CAGE CODE	DRAWING NO	RESTRICTED TO				
		114-2158									
		WEIGHT									
MATERIAL		CUSTOMER DRAWING		SCALE		8:1		SHEET	OF	REV	A
HOUSING:		CONTACT: 3		1							
CONTACTS:		CONTACT: 3		1							
FINISH		CONTACT: 3		1							